

C1812J105K5RACTU

Aliases (C1812J105K5RAC7800) SMD Comm X7R FO, Ceramic, 1 uF, 10%, 50 VDC, X7R, SMD, MLCC, Open Mode, Temperature Stable, 1812, 2.3 mm



General Information	
Series	SMD Comm X7R FO
Style	SMD Chip
Description	SMD, MLCC, Open Mode, Temperature Stable
Features	Open Mode, Temperature Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	185 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		
Chip Size	1812	
L	4.5mm +/-0.4mm	
W	3.2mm +/-0.3mm	
Т	1.7mm +/-0.20mm	
S	2.3mm MIN	
В	0.7mm +/-0.35mm	

Pack

	4.5mm +/-0.4mm	Measure
	3.2mm +/-0.3mm	Tolerand
	1.7mm +/-0.20mm	Voltage
	2.3mm MIN	Dielectr
	0.7mm +/-0.35mm	Tempera
		Temp. C
aging Specifications		Capacita

Specifications	
Capacitance	1uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	1GOhms

Packaging	T&R, 180mm, Plastic Tape	Applied (TCC)
Packaging Quantity	1000	Dissipation Factor
		Aging Rate

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